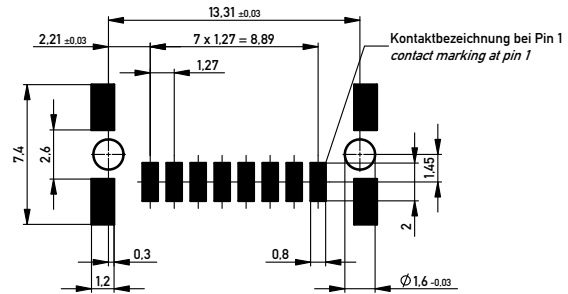
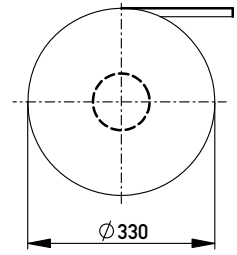


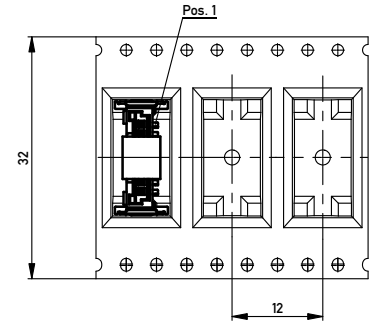
Leiterplatten-Layout für SMT
PCB-Layout for SMT



Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 650 Stück
Packaging unit: 650 pcs



Abspulrichtung - Reel off Direction



Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0.1 mm
Coplanarity Area of Termination ≤ 0.1 mm

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Information:		Tolerances	Scale 5:1	Für die Anforderung nach PG 9 der LV214 (Koshiri-Sicherheit)	
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Subject to modification without prior notice. Drawing will not be updated.		Designation		M 1.27 SRC P. 8-polig KS M 1.27 SRC P. 8-pin KS	
www.ERNI.com		474818		I A2	
b	24.03.2014	Class		SRCPC	
Index	Date				